

# **Dual Wavelength SMD Type Emitter**

### **Features**

- Top view 0805 package
- Viewing Angle = ±65°
- Compatible with infrared and vapor phase reflow solder process
- High reliability
- Dual dominant wavelength (G=525nm, R=621nm)
- RoHS compliance

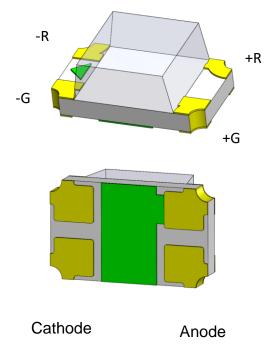
### **Applications**

- Optical indicator.
- Switch and Symbol Display.

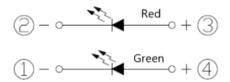
### **Description**

The GRP201208-CTC3 is a double LED housed in a miniature SMD package. The device has a dominant wavelength of 525 nm and 621 nm LED.

### **Package Outline**



### **Schematic**





# GRP201208-CTC3 Dual Wavelength SMD Type Emitter

# Absolute Maximum Rating at 25°C

Symbol	nbol Parameters		Ratings	Units	Notes
I_	Continuous Forward Current	G	25	mA	
I <sub>F</sub>		R	25	IIIA	
1	Peak Forward Current	G	60	A	4
IFP	I <sub>FP</sub> Peak Forward Current		100	mA	Į.
V <sub>R</sub>	Reverse Voltage	5	V		
Topr	T <sub>opr</sub> Operating Temperature		-40 ~ +85	°C	
T <sub>stg</sub>	T <sub>stg</sub> Storage Temperature		-40 ~ +100	°C	
T <sub>sol</sub>	T <sub>sol</sub> Soldering Temperature		260	°C	2
D-	Power Dissipation at(or below) 25°C Free Air		95	m\/\	
P <sub>D</sub> Temperature		R	60	mW	

# Electro-Optical Characteristics TA = 25°C (unless otherwise specified)

**Optical Characteristics (Green)** 

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
lv	Luminous Intensity	I <sub>F</sub> =5mA	225	-	565	mcd	3
$\lambda_{p}$	Peak Wavelength	I <sub>F</sub> =5mA	-	516	-	nm	
λ <sub>D</sub>	Dominant Wavelength	I <sub>F</sub> =5mA	520	-	535	nm	4
θ1/2	Angle of Half Intensity	I <sub>F</sub> =5mA	-	±65	-	deg	

### **Electrical Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
V <sub>F</sub>	Forward Voltage	I <sub>F</sub> =5mA	2.4	-	3.1	V	
I <sub>R</sub>	Reverse Current	V <sub>R</sub> =5V	-	-	1	μΑ	

### **Optical Characteristics (Red)**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
lv	Luminous Intensity	I <sub>F</sub> =5mA	36	-	90	mcd	3
$\lambda_{p}$	Peak Wavelength	I <sub>F</sub> =5mA	-	632	-	nm	
λ <sub>D</sub>	Dominant Wavelength	I <sub>F</sub> =5mA	-	621	-	nm	
θ1/2	Angle of Half Intensity	I <sub>F</sub> =5mA	-	±65	-	deg	



# **Dual Wavelength SMD Type Emitter**

### **Electrical Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward Voltage	I <sub>F</sub> =5mA	1.6	-	2.1	V	
I <sub>R</sub>	Reverse Current	V <sub>R</sub> =5V	-	-	1	μΑ	

#### Notes:

- 1. I<sub>FP</sub> Conditions--Pulse Width≦ 100µs and Duty≦ 10%.
- 2. Soldering time ≤ 10 seconds.
- 3. Bin Range of Luminous Intensity

Green							
Bin Code	Min	Max	Unit	Condition			
SA	225	360	mcd	I <sub>F</sub> =5mA			
TA	360	565	mca	IF=5IIIA			
	Red						
Bin Code	Min	Max	Unit	Condition			
NA	36.0	57.0	mad	I <sub>F</sub> =5mA			
PA	57.0	90.0	mcd	AMC≡₁i			

Tolerance of: Luminous Intensity  $\pm 10\%$ 

### 4. Bin Range of Dominant Wavelength

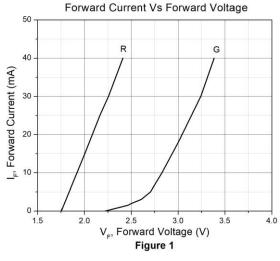
	Green					
Bin Code	Min	Max	Unit	Condition		
A5	520	525				
A6	525	530	nm	I <sub>F</sub> =5mA		
A7	530	535				

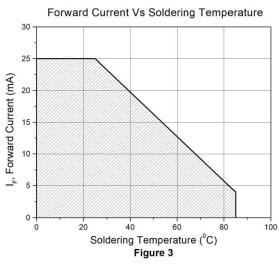
Tolerance of Dominant Wavelength:  $\pm 1$ nm.

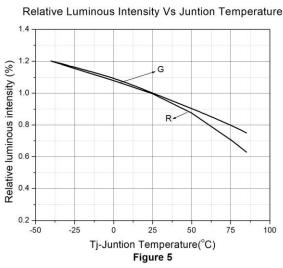


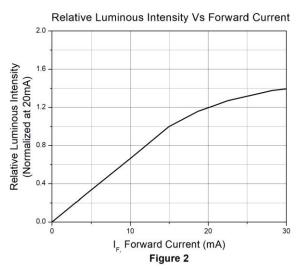
# **Dual Wavelength SMD Type Emitter**

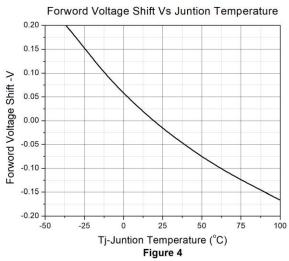
# **Typical Characteristic Curves**

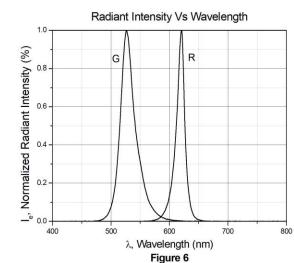










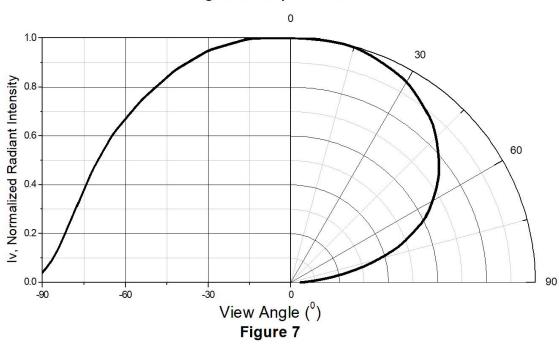




# **Dual Wavelength SMD Type Emitter**

# **Typical Characteristic Curves**

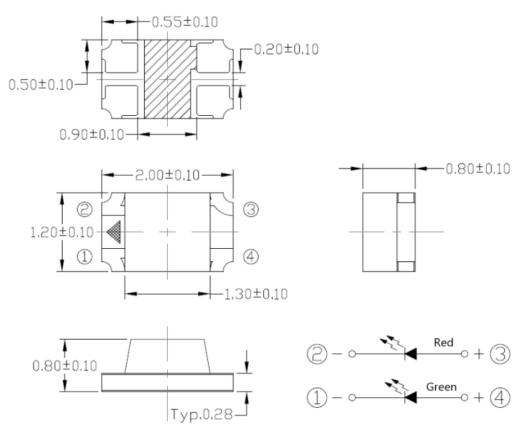
# Angular Displacement





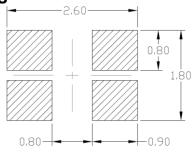
# **Dual Wavelength SMD Type Emitter**

### Package Dimension All dimensions are in mm, unless otherwise stated



Note: Tolerance unless mentioned is ±0.1mm.

# Recommended Soldering Mask All dimensions are in mm, unless otherwise stated



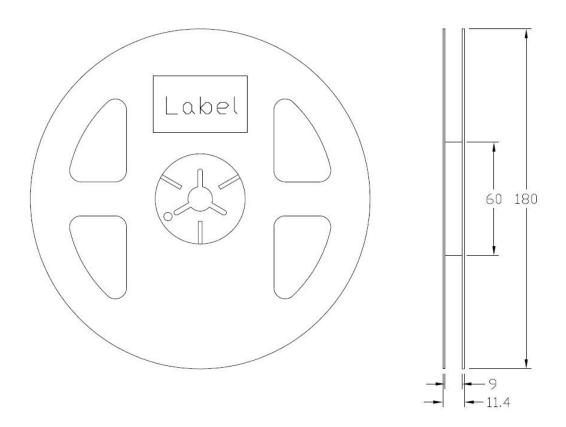
Note: Tolerance unless mentioned is ±0.1mm.

# **Ordering Information**

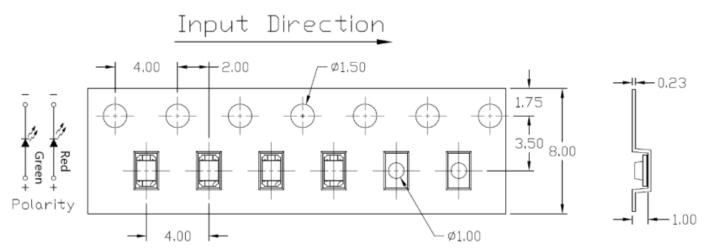
Part Number	Description	Quantity
GRP201208-CTC3	Tape & Reel	3000 pcs

# **Dual Wavelength SMD Type Emitter**

### Reel Dimension All dimensions are in mm, unless otherwise stated



### Tape Dimension All dimensions are in mm, unless otherwise stated

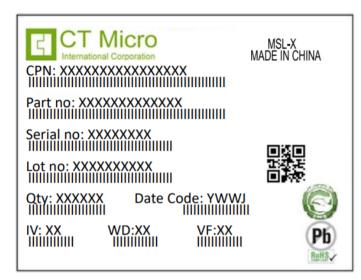


Note: Tolerance unless mentioned is ±0.1mm.



# **Dual Wavelength SMD Type Emitter**

### **Label Form Specification**



CPN : Customer Part Number Part no: CTM Production Number

Serial no: Production Number

Lot no: Lot number

Q'ty: Packing Quantity

Date Code: Manufacture Date

IV: Bin Code of Luminous Intensity

WD : Bin Code of Dominant Wavelength

VF : Bin Code of Forward Voltage

MADE IN CHINA: Production Place

### **Storage Condition**

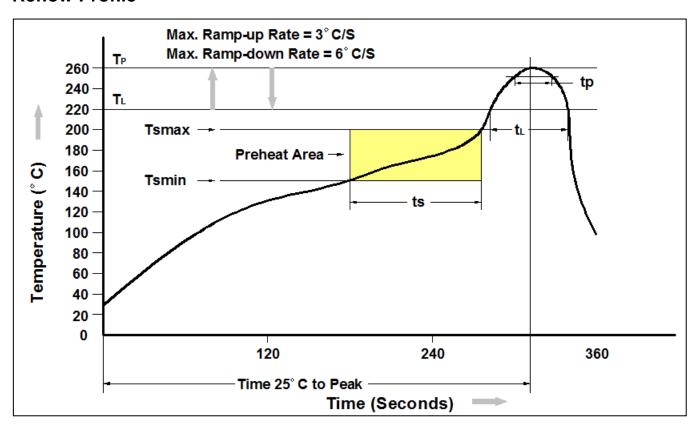
- 1. Do not open moisture proof bag before the products are ready to use.
- 2. The moisture barrier bag should be stored at 30°C and 90%R.H. max. before opening. Shelf life of non-opened bag is 12 months after the bag sealing date.
- 3. After opening the moisture barrier bag floor life is 1 year at 30°C/60%RH. max. Unused LEDs should be resealed into moisture barrier bag. (Refer to J-STD-020 Standard)
- 4. If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the J-STD-033 Standard conditions.





# **Dual Wavelength SMD Type Emitter**

### **Reflow Profile**



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t∟ to t⊳)	3°C/second max.
Liquidous Temperature (T <sub>L</sub> )	217°C
Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> )	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t <sub>P</sub> ) within 5°C of 260°C	30 seconds
Ramp-down Rate (T <sub>P</sub> to T <sub>L</sub> )	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



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